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GaN HEMT 28V, 40W, General purpose RF Power Transistor Description

The GTAH40040C6 is a 40W GaN HEMT, designed for multiple applications, up to 4GHz.

The transistor is available in a highly cost effective 10*6mm, surface mount, QFN package with

100% DC production test to ensure the quality and consistency.

It can be used in CW, Pulse and any other modulation modes.

There is no guarantee of performance when this part is used in applications designed Outside of these frequencies.

Typical Class AB RF Performance with device soldered through high density and plated grounding vias Vds = 28V, Idq = 35mA,Vgs=-2.64V

Freq	P1dB	P1dB	P1dB	P1dB	P3dB	P3dB	P3dB
(MHz)	(dBm)	(W)	Eff(%)	Gain(dB)	(dBm)	(W)	Eff(%)
2400	46.41	43.7	63.7	18.44	47.5	56.2	70.8
2450	45.96	39.4	64.3	18.24	47.12	51.5	71.5
2500	45.37	34.5	63.8	17.91	46.78	47.6	71.9

Applications

- S band power amplifier
- L band power amplifier
- ISM/RF Energy power amplifier

Important Note: Proper Biasing Sequence for GaN HEMT Transistors

Turning the device ON

Turning the device OFF

1. Turn RF power off

- 1. Set VGS to the pinch--off (VP) voltage, typically –5 V
- 2. Turn on VDS to nominal supply voltage
- 3. Increase VGS until IDS current is attained
- 4. Apply RF input power to desired level

- 2. Reduce VGS down to VP, typically -5 V
- 3. Reduce VDS down to 0 V
- 4. Turn off VGS

Figure 1: Pin Connection definition

Transparent top view (Backside grounding for source)

6 5 4	3 2 1 4
	0/36
8	35
9	34
10]	33
11	32
12	[31]
13]	30
14	29
15	28
16	27
17]	26
18/	25
19 20 21	22 23 24

Pin No.	Symbol	Description
8,9,10,11,14,15,16,17	RF IN/Vgs	RF Input, Vgs bias
26,27,28,29,32,33,34,35	RF OUT/VDD	RFOutput, Drain bias



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Rest Pins and Package Base	nd Package Base GND		DC/RF Ground. Must be soldered directly to heatsink or copper coin for CW application.			
Table 1. Maximum Ratings		·				
Rating		Symbol	Value	Unit		
DrainSource Voltage		V _{DSS}	+150	Vdc		
GateSource Voltage		V _{GS}	V _{GS} -8 to +0.5			
Operating Voltage		V _{DD} 36		Vdc		
Maximum gate current		lgs	10.8	mA		
Storage Temperature Range		Tstg	-65 to +150	°C		
Case Operating Temperature		Tc	+150	°C		
Operating Junction Temperature		TJ	+225	°C		

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case by FEA	Data	2	°C /W
T _c = 85°C, at Pdiss=20W	Rejc	3	-0.700

Table 3. Electrical Characteristics (TA = 25°C unless otherwise noted)

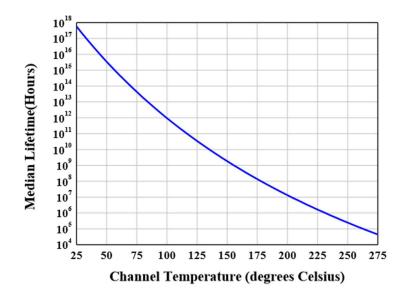
DC Characteristics (main path, measured on wafer prior to packaging)

Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Drain-Source Breakdown Voltage	VGS=-8V; IDS=10.8mA	V _{DSS}		200		V
Gate Threshold Voltage	VDS =10V, ID = 10.8mA	V _{GS(th)}	-4		-2	V
Gate Quiescent Voltage	y VDS =28V, IDS=35mA, Measured in Functional Test			-2.64		V

Ruggedness Characteristics

Characteristic	Conditions	Symbol	Min	Тур	Max	Unit
Load mismatch capability	2.5GHz, Pout=40W Pulsed CW					
	All phase,	VSWR		10:1		
	No device damages					

Figure 2: Median Lifetime vs. Channel Temperature



Typical performance

Figure 3: Efficiency and power gain as function of Pout

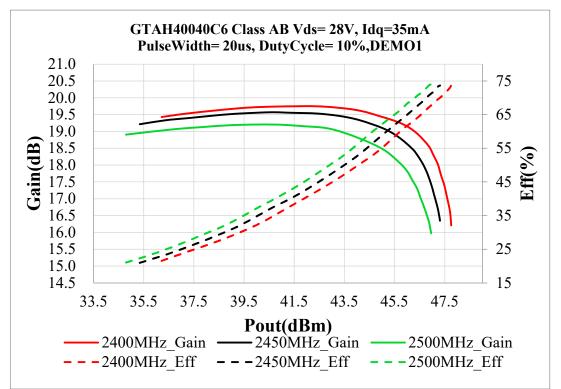


Figure 4: Network analyzer output S11/S21

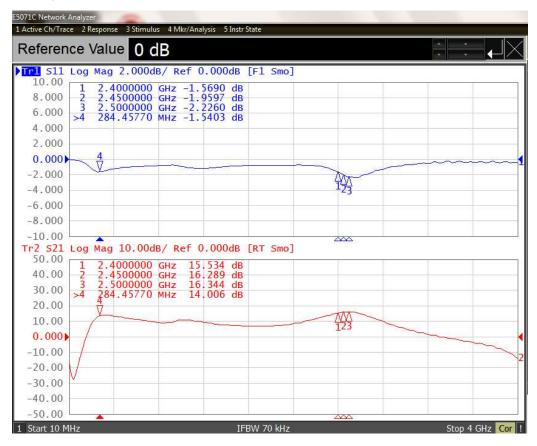


Figure 5: Picture of application board

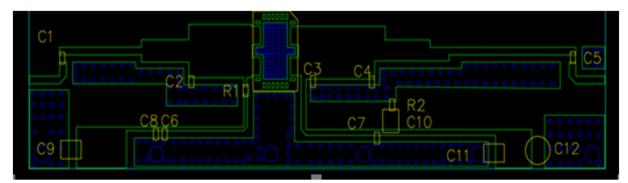
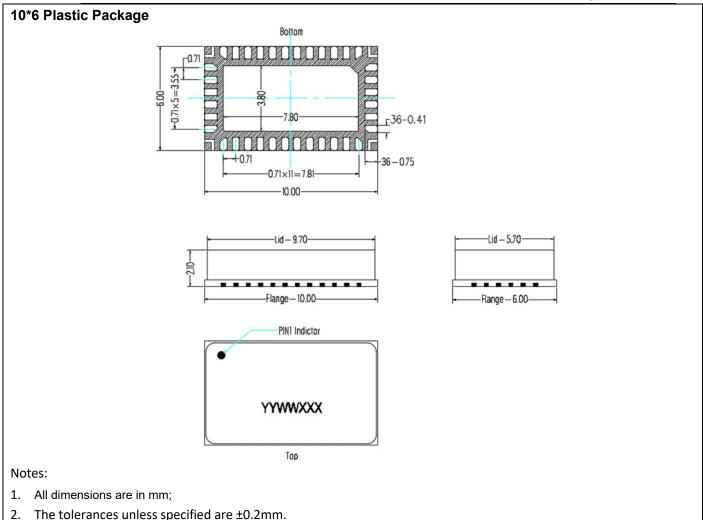


Table 4. Bill of materials of application board (PCB layout upon request, RO4350B 20mils)

Component	Value	Quantity
U1	GTAH40040C6	1
C1	5.1pF	1
C5、C6、C7	12pF	3
C9、C10、C11	10uF/63V	3
C8	10uF/16V	1
R1、R2	10 Ω	2
C12	470uF/63V	1
C2 、C3	1.6pF	2
C4	0.8pF	1

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Revision history

Table 4. Document revision history

Date	Revision	Datasheet Status
2023/11/8	V1.0	Preliminary Datasheet Creation

Application data based on: ZYX-23-11

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